

SURFACE MOUNT DISPLAY

KPDA56-107 SUPER BRIGHT YELLOW

Features

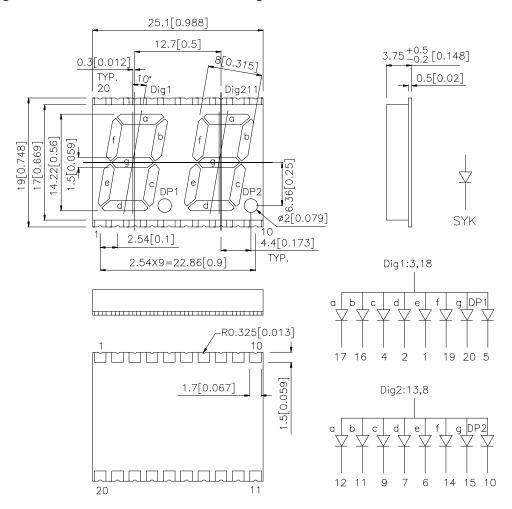
- •0.56 INCH DIGIT HEIGHT.
- •LOW CURRENT OPERATION.
- •EXCELLENT CHARACTER APPEARANCE.
- •I.C. COMPATIBLE.
- •MECHANICALLY RUGGED.
- •GRAY FACE, WHITE SEGMENT.
- •PACKAGE:400PCS/REEL.

Description

The Super Bright Yellow source color devices are made with DH InGaAIP on GaAs substrate Light Emitting Diode.

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Package Dimensions & Internal Circuit Diagram



Notes:

- 1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25 (0.01")$ unless otherwise noted.
- 2. Specifications are subject to change whitout notice.

 SPEC NO: DSAA9178
 REV NO: V.2
 DATE:SEP/04/2002

 APPROVED: J. Lu
 CHECKED: Joe Lee
 DRAWN: L.ZHANG



Selection Guide

Part No.	Dice	Lens Type	lv (ucd) @ 10 mA		Description	
			Min.	Тур.		
KPDA56-107	SUPER BRIGHT YELLOW (InGaAIP)	WHITE DIFFUSED	18000	42100	Common Anode, Rt. Hand Decimal	

Electrical / Optical Characteristics at T_A=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Yellow	590		nm	IF=20mA
λD	Dominate Wavelength	Super Bright Yellow	590		nm	I _F =20mA
Δλ1/2	Spectral Line Half-width	Super Bright Yellow	20		nm	I _F =20mA
С	Capacitance	Super Bright Yellow	20		pF	V _F =0V;f=1MHz
VF	Forward Voltage	Super Bright Yellow	2.0	2.5	V	IF=20mA
IR	Reverse Current	Super Bright Yellow		10	uA	V _R = 5V

Absolute Maximum Ratings at T_A=25°C

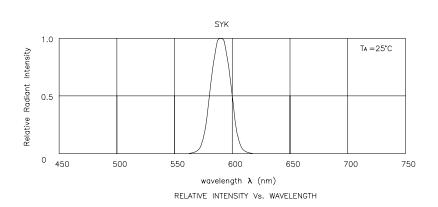
Parameter	Super Bright Yellow	Units
Power dissipation	125	mW
DC Forward Current	30	mA
Peak Forward Current [1]	175	mA
Reverse Voltage	5	V
Operating/Storage Temperature -40°C To +85°C		

Note

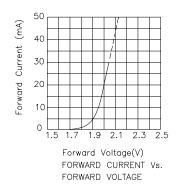
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

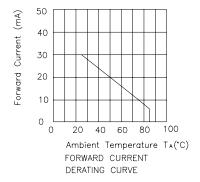
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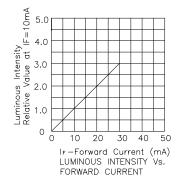


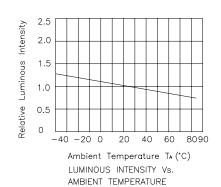


Super Bright Yellow KPDA56-107







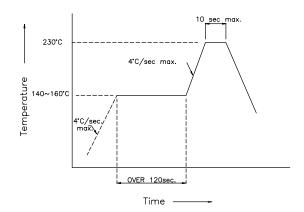


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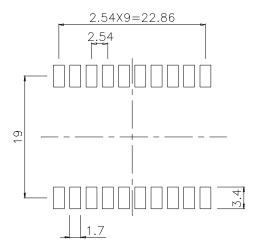
Kingbright

KPDA56-107 SMT Reflow Soldering Instruction

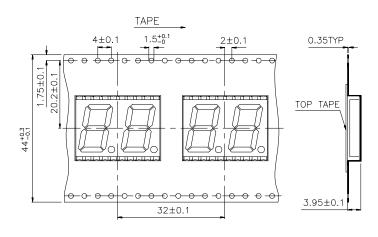
Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and second soldering process.



Recommended Soldering Pattern (Units:mm)



Tape Specification (Units:mm)



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